

L Number	Hits	Search Text	DB	Time stamp
1	2	("4526649").PN.	USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:14
2	2	gb-2022490-\$.did.	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:21
3	0	silicon same infiltration same molton same cvd	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:23
4	2	silicon same molton same cvd	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:26
5	4	silicon same infiltration same molten same cvd	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:23
6	156	silicon same molten same cvd	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:26
7	11	(silicon same molten same cvd) and infiltration	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:35
8	172	silicon same carbide same key	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:36
9	10	silicon same carbide same key same infiltration	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB USPÄT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/03/26 15:36

L Number	Hits	Search Text	DB	Time stamp
1	18	US-4070197-\$.DID. OR US-4238540-\$.DID. OR US-4592268-\$.DID. OR US-4608318-\$.DID. OR US-4621001-\$.DID. OR US-4921554-\$.DID. OR US-5526867-\$.DID. OR US-5585190-\$.DID. OR US-6162019-\$.DID.	USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB	2004/03/26 13:38
3	2292	silicon adj carbide and (join or joined or joining) and adhesive	USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB	2004/03/26 13:39
4	284	(silicon adj carbide and (join or joined or joining) and adhesive) and (infiltrate or infiltrant or infiltrating or infiltration or infiltrated)	USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB	2004/03/26 13:40
5	47	((silicon adj carbide and (join or joined or joining) and adhesive) and (infiltrate or infiltrant or infiltrating or infiltration or infiltrated)) and (key or keyed or keying)	USPAT; US-PGPUB; EPO; JPO; DERMENT; IBM TDB	2004/03/26 13:40